

RF & MICROWAVE TRANSISTORS S-BAND RADAR APPLICATIONS

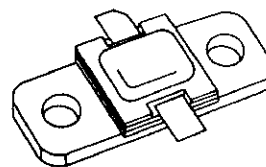
- REFRACTORY/GOLD METALLIZATION
- EMITTER SITE BALLASTED
- RUGGEDIZED VSWR 3:1 @ 1dB OVERDRIVE
- LOW THERMAL RESISTANCE
- INPUT/OUTPUT MATCHING
- OVERLAY GEOMETRY
- METAL/CERAMIC HERMETIC PACKAGE
- $P_{OUT} = 50 \text{ W MIN. WITH } 5.2 \text{ dB GAIN}$

DESCRIPTION

The AM83135-050 device is a high power silicon bipolar NPN transistor specifically designed for S-Band radar pulsed output and driver applications.

This device is characterized at 10 μsec pulsewidth and 10% duty cycle, but is capable of operation over a range of pulse widths, duty cycles and temperatures and can withstand a 3:1 output VSWR with a +1 dB input overdrive. Low RF thermal resistance, refractory/gold metallization, and computerized automatic wire bonding techniques ensure high reliability and product consistency (including phase characteristics).

The AM83135-050 is supplied in the IMPAC™ Hermetic Metal/Ceramic package with internal Input/Output impedance matching circuitry, and is intended for military and other high reliability applications.



.310 x .310 2LFL (S064)

hermetically sealed

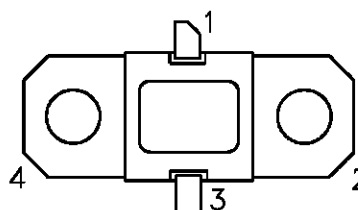
ORDER CODE

AM83135-050

BRANDING

83135-50

PIN CONNECTION



1. Collector

2. Base

3. Emitter

4. Base

ABSOLUTE MAXIMUM RATINGS ($T_{case} = 25^{\circ}\text{C}$)

Symbol	Parameter	Value	Unit
P_{DISS}	Power Dissipation* ($T_C \leq 125^{\circ}\text{C}$)	312	W
I_C	Device Current*	8.0	A
V_{CC}	Collector-Supply Voltage*	48	V
T_J	Junction Temperature (Pulsed RF Operation)	250	$^{\circ}\text{C}$
T_{STG}	Storage Temperature	- 65 to +200	$^{\circ}\text{C}$

THERMAL DATA

$R_{TH(j-c)}$	Junction-Case Thermal Resistance*	0.40	$^{\circ}\text{C/W}$
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*Applies only to rated RF amplifier operation

ELECTRICAL SPECIFICATIONS ($T_{\text{case}} = 25^{\circ}\text{C}$)**STATIC**

Symbol	Test Conditions		Value			Unit
			Min.	Typ.	Max.	
BV_{CBO}	$I_{\text{C}} = 25\text{mA}$	$I_{\text{E}} = 0\text{mA}$	55	—	—	V
BV_{EBO}	$I_{\text{E}} = 5\text{mA}$	$I_{\text{C}} = 0\text{mA}$	3.5	—	—	V
BV_{CER}	$I_{\text{C}} = 25\text{mA}$	$R_{\text{BE}} = 10\text{W}$	55	—	—	V
I_{CES}	$V_{\text{BE}} = 0\text{V}$	$V_{\text{CE}} = 42\text{V}$	—	—	20	mA
h_{FE}	$V_{\text{CE}} = 5\text{V}$	$I_{\text{C}} = 3\text{A}$	30	—	300	—

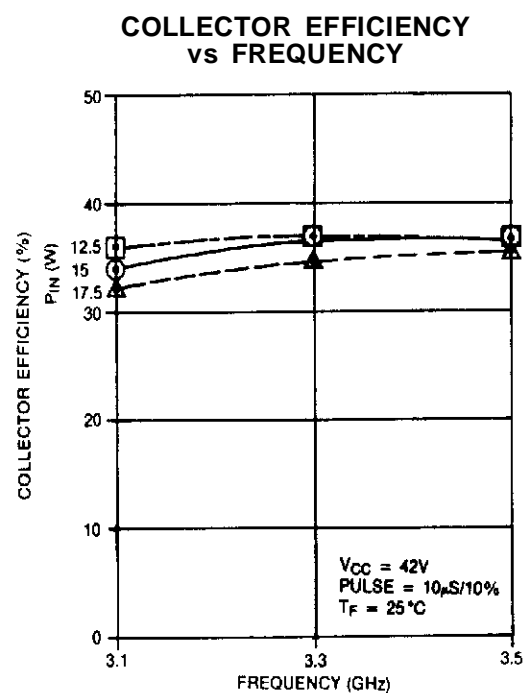
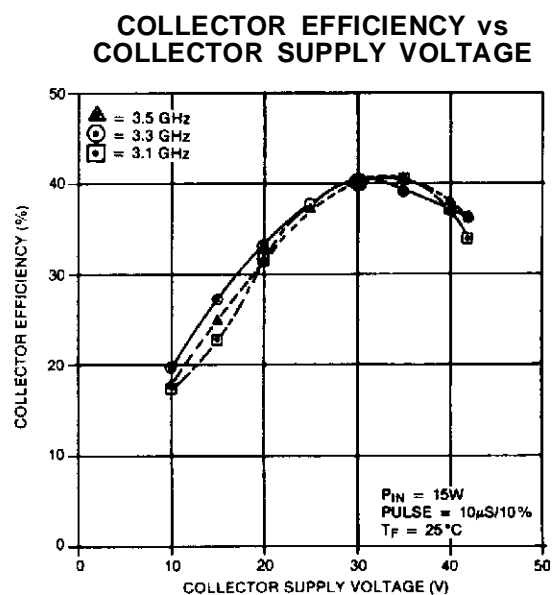
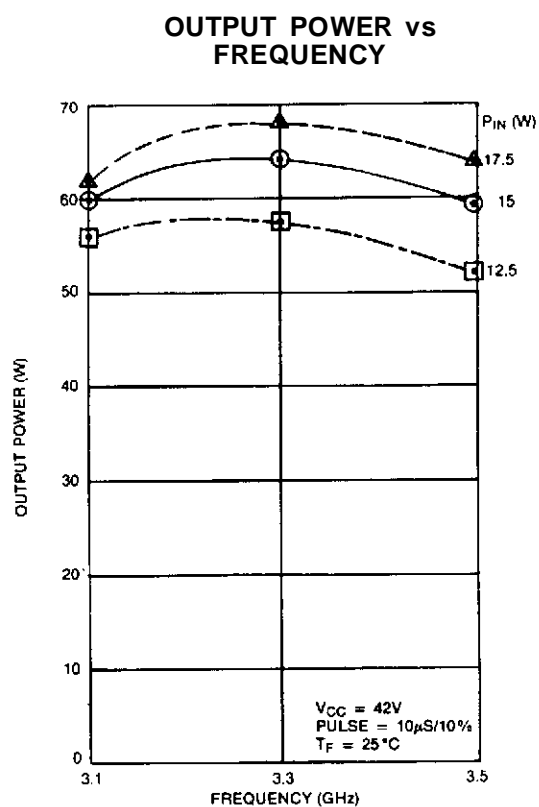
DYNAMIC

Symbol	Test Conditions			Value			Unit
				Min.	Typ.	Max.	
P_{OUT}	$f = 3.1 - 3.5\text{GHz}$	$P_{\text{IN}} = 15\text{W}$	$V_{\text{CC}} = 42\text{V}$	50	—	—	W
η_{C}	$f = 3.1 - 3.5\text{GHz}$	$P_{\text{IN}} = 15\text{W}$	$V_{\text{CC}} = 42\text{V}$	30	—	—	%
G_{P}	$f = 3.1 - 3.5\text{GHz}$	$P_{\text{IN}} = 15\text{W}$	$V_{\text{CC}} = 42\text{V}$	5.2	—	—	dB

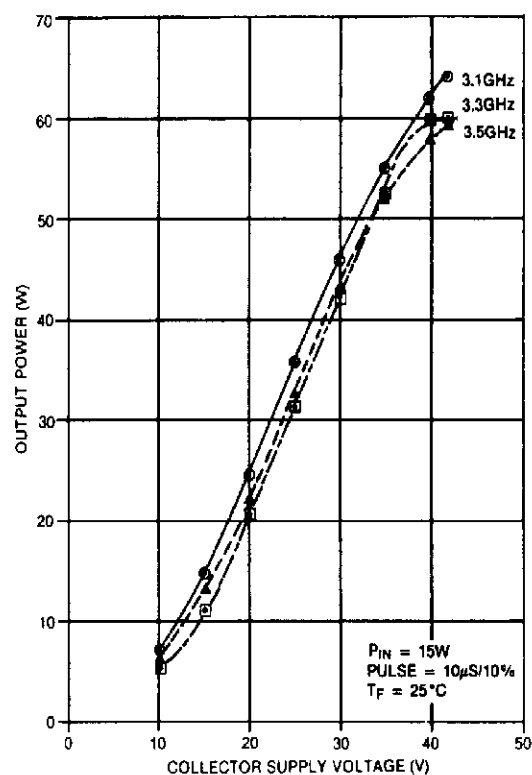
Note: Pulse Width = 10 μ Sec

Duty Cycle = 10%

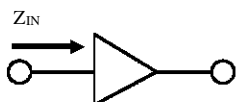
TYPICAL PERFORMANCE



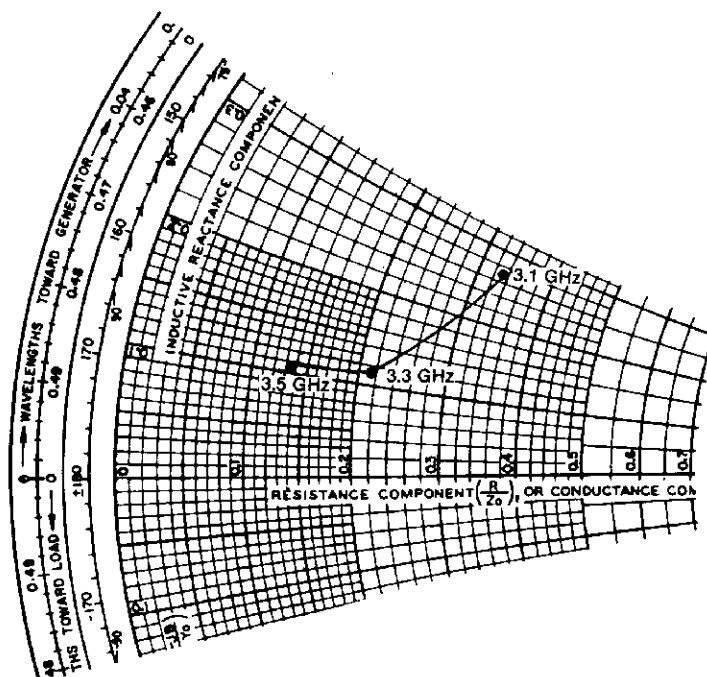
OUTPUT POWER vs COLLECTOR SUPPLY VOLTAGE



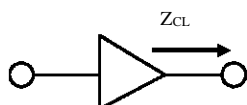
IMPEDANCE DATA

TYPICAL INPUT
IMPEDANCE

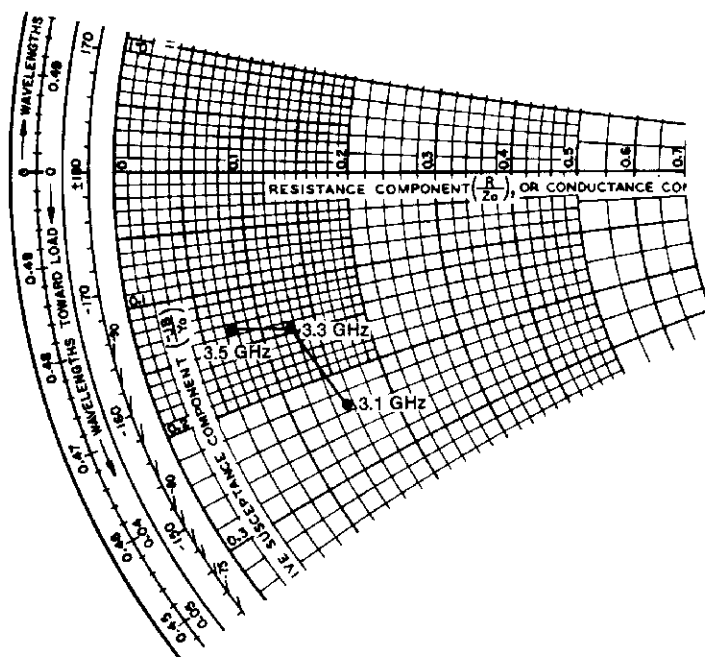
$P_{IN} = 15 \text{ W}$
 $V_{CC} = 42 \text{ V}$
 $Z_0^* = 50 \text{ ohms}$



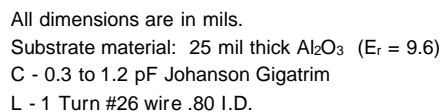
FREQ.	$Z_{IN} (\Omega)$	$Z_{CL} (\Omega)$
L = 3.1 GHz	$16.5 + j 13.5$	$7.7 - j 11.8$
M = 3.3 GHz	$10.8 + j 5.5$	$6.5 - j 7.2$
H = 3.5 GHz	$6.7 + j 5.2$	$3.8 - j 6.7$

TYPICAL COLLECTOR
LOAD IMPEDANCE

$P_{IN} = 15 \text{ W}$
 $V_{CC} = 42 \text{ V}$
 $Z_0^* = 50 \text{ ohms}$

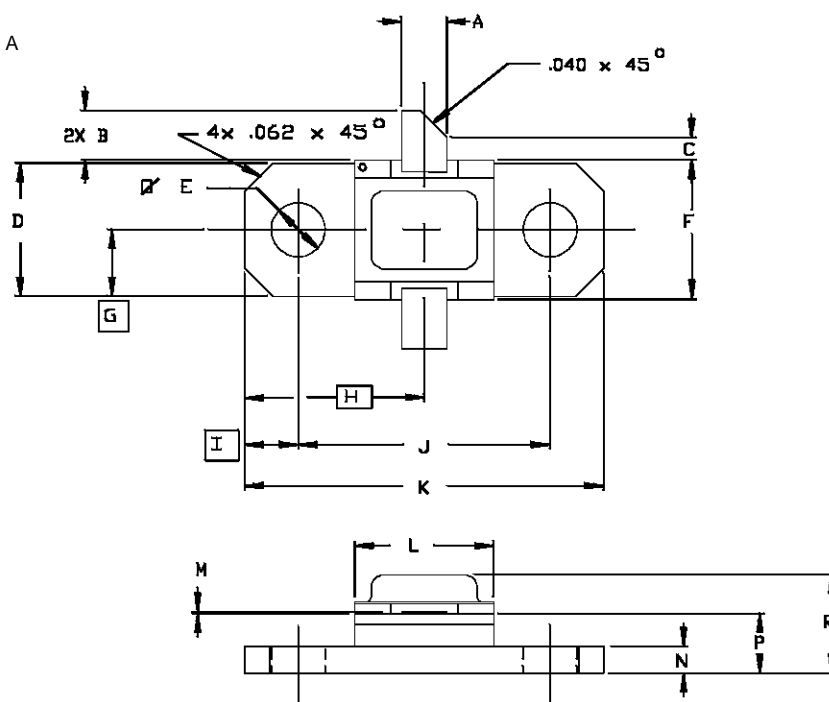


*Normalized



PACKAGE MECHANICAL DATA

Ref.: Dwg. No. 12-0221
UDCS No. 1011424 rev A



SGS-THOMSON MICROELECTRONICS			CONT'D		
	MINIMUM Inches/mm	MAXIMUM Inches/mm		MINIMUM Inches/mm	MAXIMUM Inches/mm
A	.095/2,41	.105/2,67	K	.790/20,07	.810/20,57
B	.100/2,54	.120/3,05	L	.300/7,62	.320/8,13
C	.050/1,27		M	.003/0,08	.006/0,15
D	.286/7,26	.306/7,77	N	.052/1,32	.072/1,83
E	.110/2,79	.130/3,30	P	.118/3,00	.131/3,33
F	.306/7,77	.318/8,08	R		.230/5,84
G	.148/3,76				
H	.400/10,16				
I	.119/3,02				
J	.552/14,02	.572/14,53			

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